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TRANSMITTAL FORM (to be used for all correspondence after initial filing)		Application No.	10/816,234
		Filing Date	March 31, 2004
		First Named Inventor	Daoqiang Lu
		Art Unit	2812
		Examiner Name	Not Yet Assigned
Total Number of Pages in This Submission	10	Attorney Docket Number	42P19140

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Attorney's Docket No. 042390.P19140

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:)

Daoqiang Lu, et al)

Application No: 10/816,234)

Filed: March 31, 2004)

For: Wafer Support And Release In)
Wafer Processing)

Examiner: Not Yet Assigned

Art Unit: 2812

Commissioner for Patents
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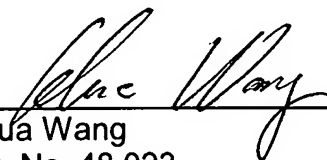
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Respectfully submitted,

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Dated: 12/1, 2004



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INFORMATION DISCLOSURE STATEMENT BY APPLICANT		Application Number	10/816,234
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		First Named Inventor	Daoqiang Lu
		Art Unit	2812
		Examiner Name	Not Yet Assigned
		Attorney Docket Number	42P19140
Sheet	1	of	1

NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No.†	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T‡
		AI TECHNOLOGY, Dicing and Lapping Tapes for Wafer and Substrate. Product-line Overview. Copyright 2001 A.I. Technology, Inc. Last modified 9/18/2001. Pages 1-2.	
		ASI ADHESIVES & SEALANTS INDUSTRY, UV/EB-Curable Acrylate Silicones for Release Coatings. Posted on 5/29/2002. Pages 1-6.	
		Lamination Process UV Release Films. Lamination Process for UV Releasing Dicing Tape to Wafer-Substrate. Page 1-2.	
		POLYMER BULLETIN, Concentration effects of methylalumoxane, palladium and nickel pre-catalyst and monomer in the vinyl polymerization of norbornene by Christoph Janiak and Paul-Gerhard Lassahn. 2/27/2001.	
		IZM, New Process Scheme for Wafer Thinning and Stress-free Separation of Ultra Thin ICs by C. Landesberger, et al. Microsystems Technologies 2001. pp. 431-436.	
		INSTITUTE OF PHYSICS PUBLISHING, Sacrificial polymers for nanofluidic channels in biological applications by Wanli Li, et al. Published 4/14/2003.	

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